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5C/1085 U.S. UTILITY Patent Application

PATENT NUMBER and  
ISSUE DATE

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10002544	11/21/2001	205	157	1741	Leader

\*\*APPLICANTS: Liu Chung-Shi; Yu Chen-Hua;

\*\*CONTINUING DATA VERIFIED:

\*\* FOREIGN APPLICATIONS VERIFIED:

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO	
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		67,200-535	
Verified and Acknowledged Examiners's initials			
TITLE : Method for forming cathode contact areas for an electroplating process			
U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)			

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drawg.	Figs. Drawg.
		Print Fig.	
Primary Examiner		Application Examiner	
PREPARED FOR ISSUE			
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